

HIGH SPEED CONNECTORS



✓ Active

TE CONNECTIVITY (TE) IMP100S,H,V6P16C,LG,REW39,4.9

IMPACT | IMPACT

2007891-2

TE Internal Number: 2007891-2

EU RoHS Compliant EU ELV Compliant

Connector System Board-to-Board **Number of Positions 288** Row-to-Row Spacing (mm) 1.35 Mating Alignment With Mating Alignment Type Keyed



PRODUCT DRAWING

English



★ 3D PDF

DOCUMENTATION

Product Drawings

IMPACT, 6 PAIR, 16 COLUMN, HEADER LEFT GUIDED, RIGHT END WALL SIGNAL MODULE, 0.3

PDF

English

CAD Files

3D PDF

PDF

3D

Customer View Model

2D_DXF.ZIP

English

Customer View Model

3D_IGS.ZIP

English

Customer View Model

3D_STP.ZIP

English

Product Specifications

Application Specification

Impact 100-Ohm Standard Connector System

PDF

English

Product Specification

IMPACT 100 Ohm Interconnect Systems

PDF

English

Product Environmental Compliance

TE Material Declaration

MD_2007891-2_10062015854_dmtec

PDF

English

FEATURES

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Please review product documents or contact us for the latest agency approval information.

Please Note: Use the Product Drawing for all design activity.

Product Type Features

Connector System Board-to-Board

Row-to-Row Spacing (mm) 1.35

Connector Style Plug

PCB Mounting Orientation Vertical

Shrouded Fully Shrouded

Connector & Contact Terminates To Printed Circuit Board

Connector Type Header

Product Type Connector

Make First / Break Last No

Configuration Features

Stackable No

Number of Pairs 96

Number of Positions 288

Number of Rows 18

Number of Columns 16

Board-to-Board Configuration Right Angle, Vertical

Guide Location Left

Tail Orientation Inline

Number of Signal Positions 192

Number of Ground Positions 96

Electrical Characteristics

Impedance (Ω) 100

Operating Voltage (VDC) 30

Operating Voltage (VAC) 30

Signal Characteristics

Data Rate (Gb/s) 20 – 25

Differential Pairs per Column 6

Differential Signaling Yes

Contact Features

Underplate Material Nickel

Contact Length 4.9 mm [.193 in]

Contact Current Rating (Max) (A) .75

Contact Termination Area Plating Thickness $.76 - 1.52 \,\mu m$ [$29.921 - 59.842 \,\mu in$]

Contact Mating Area Plating Thickness .76 µm [29.92 µin]

Contact Termination Area Plating Material Tin

Contact Design Dual Beam

Contact Mating Area Plating Material Gold

Contact Termination Area Plating Material Finish Matte

Contact Style Press-Fit

Contact Base Material Copper Alloy

Contact Transmits (Typical) Signal (Data)

Underplate Material Thickness 1.27 µm [50 µin]

Contact Type Pin

Termination Features

Termination Method to PC Board Through Hole - Press-Fit

Mechanical Attachment

Guide Hardware With

Mating Alignment With

Mating Alignment Type Keyed

Mating Retention Without

PCB Mount Retention Type Action/Compliant Tail & Screws

PCB Mount Retention With

Housing Features

Centerline (Pitch) 1.9 mm [.075 in]

End Wall Location Right

Housing Color Black

Housing Material LCP - GF (Liquid Crystal Polymer)

Dimensions

PCB Hole Diameter .39 mm [.015 in]

Length 38.3 mm [1.508 in]

Tail Length 1.4 mm [.055 in]

Width 28.9 mm [1.138 in]

PCB Thickness (Recommended) (mm) 1

Height 28.6 mm [1.126 in]

Downloaded from Arrow.com.

Usage Conditions Operating Temperature Range $-55 - 85 \,^{\circ}\text{C} \, [-67 - 185 \,^{\circ}\text{F} \,]$ Operation/Application For Use With Receptacle Assembly **Industry Standards CSA Certified** Yes **UL Rating** Recognized **UL File Number** E28476 **UL Flammability Rating** UL 94V-0 Packaging Features Packaging Method Box & Tube, Tube **PRODUCT COMPLIANCE** Statement of Compliance **Statement of Compliance** PDF